<u>PATENT</u> ocket No.: 060188-0658

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

Customer Number: 20277

Masashi HAMANAKA, et al.

Confirmation Number: 8488

Application No.: 10/671,502

Group Art Unit: 3723

Filed: September 29, 2003

Examiner: RACHUBA, MAURINA T

For: POLISHING METHOD FOR SEMICONDUCTOR DEVICE, METHOD FOR FABRICATING SEMICONDUCTOR DEVICE AND POLISHING SYSTEM

PETITION FOR EXTENSION OF TIME

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

It is respectfully requested that the time for response to the Office Action dated January 27, 2006, now due to expire April 27, 2006, be extended for one month and set to expire on May 30, 2006, (as May 27, 2006 falls on a Saturday and Monday, May 29 is a Federal Holiday).

Please charge the extension fee of \$120.00 to Deposit Account No. 500417. Please charge any additional fees or credit any overpayment to Deposit Account No. 500417.

Respectfully submitted,

McDERMOT/ WILL & EMERY LLP

06/01/2006 HALI11

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Facsimile: 202.756.8087 Date: May 30, 2006

Michael E. Eogarty

Registration No. 36,139

Please recognize our Customer No. 20277 as our correspondence address.